

N-Channel MOSFET

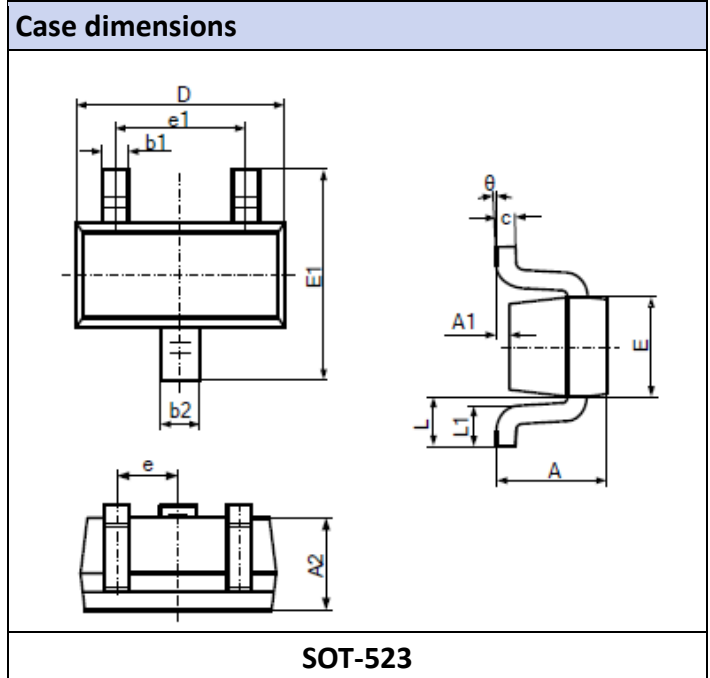
Primary characteristics			
Symbol	Parameter	Value	Unit
I_D	Continuous drain current (@ $T_C=25^\circ\text{C}$)	220	A
V_{DS}	Drain source voltage	50	V
$R_{DS(on)max}(@V_{GS}=4.5V)$	Static drain-source on-resistance	1.7	Ω

Features

- **SOT-523** case for easy automatic insertion
- Pb-free and **RoHS** compliant
- High density cell design for Low RDS(on)
- ESD protection for high speed data lines to IEC61000-4-2
- ESD contact discharge typical 8KV, max 15KV
- ESD air discharge typical 15KV. max 25KV

Application

- Switching



Unit	A	A1	A2	b1	b2	c	D
mm	0.700-0.900	0.000-0.100	0.700-0.800	0.150-0.250	0.250-0.350	0.100-0.200	1.500-1.700
Unit	E	E1	e	e1	L	L1	θ
mm	0.700-0.900	1.450-1.750	0.500	0.900-1.100	0.400	0.026-0.460	0-8°

Maximum ratings ($T_C = 25^\circ\text{C}$)			
Characteristics	Symbol	Value	Unit
Drain-source voltage	V_{DS}	50	V
Gate-source voltage	V_{GS}	± 20	V
Continuous drain current @ $T_C=25^\circ\text{C}$	I_D	220	mA
Power Dissipation @ $T_C=25^\circ\text{C}$	P_D	350	mW
Operating junction temperature range	T_J, T_{STG}	-55 ~ 150	$^\circ\text{C}$
Thermal resistance junction-ambient	$R_{\theta JA}$	357	$^\circ\text{C/W}$

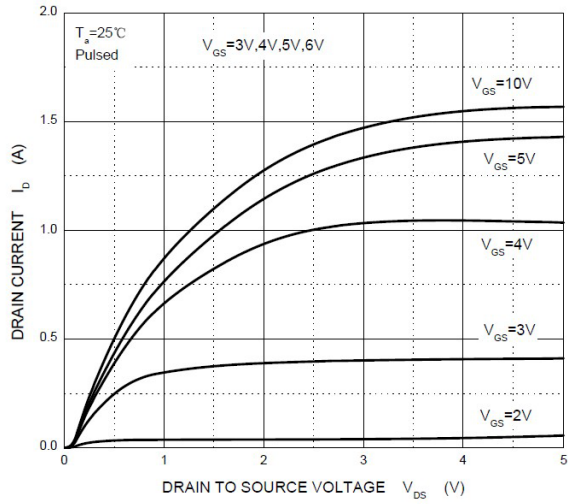
Maximum ratings (T _c = 25°C)						
Characteristics	Test condition	Symbol	Value			Unit
			Min.	Typ.	Max.	
Drain-source breakdown voltage	V _{GS} =0V, I _D =250μA	BV _{DSS}	50	-	-	V
Static drain-source on-resistance ¹	V _{GS} =10V, I _D =0.22A	R _{DS(ON)}	-	-	1.3	Ω
	V _{GS} =4.5V, I _D =0.22A		-	-	1.7	
	V _{GS} =2.2V, I _D =0.22A		-	1.75	2.0	
Gate-threshold voltage ¹	V _{DS} =V _{GS} , I _D =1mA	V _{GS(th)}	-	-	1.5	V
Drain-source leakage current	V _{DS} =50V, V _{GS} =0V, T _J =25°C	I _{DSS}	-	-	0.5	μA
Gate-source leakage current	V _{GS} =±20V, V _{DS} =0V	I _{GSS}	-	-	±100	nA
Forward transconductance ¹	V _{DS} =10V, I _D =0.22A	g _{FS}	-	120	-	mS
Turn-on delay time	V _{DD} =30V V _{GS} =10V R _G =6Ω I _D =0.29A	T _{d(on)}	-	-	5	ns
Rise time		T _r	-	-	18	
Turn-off delay time		t _{d(OFF)}	-	-	36	
Fall time		t _f	-	-	14	
Input capacitance	V _{DS} =25V V _{GS} =0V f=1.0MHz	C _{iss}	-	27	-	pF
Output capacitance		C _{oss}	-	13	-	
Reverse transfer capacitance		C _{rss}	-	6	-	
Diode forward voltage ¹	V _{GS} =0V, I _S =0.44A,	V _{SD}	-	-	1.4	V

Notes:

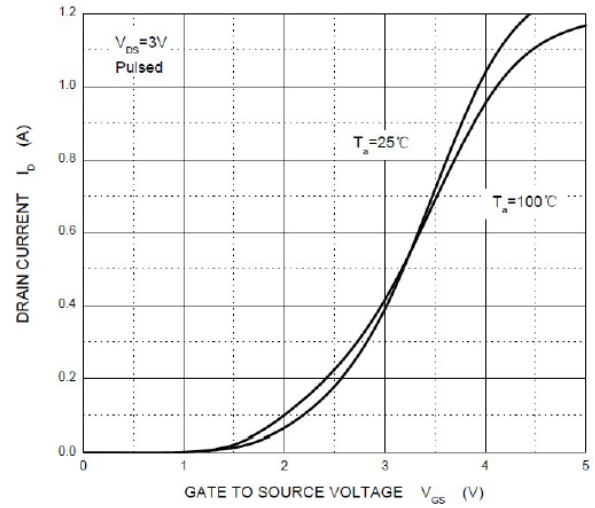
1. Pulse Test ;Pulse Width ≤300us,Duty Cycle ≤2%.

Typical characteristics

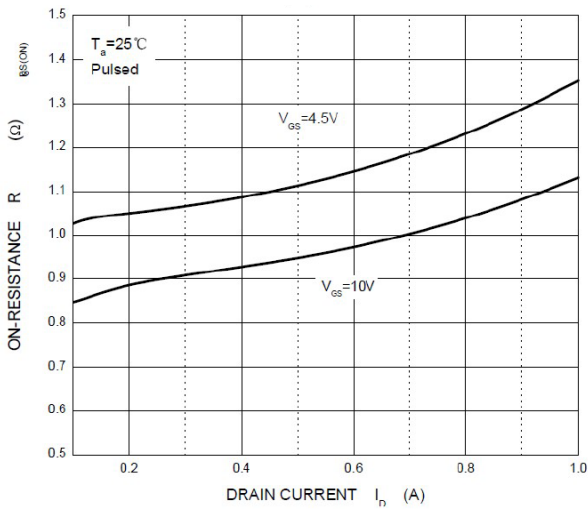
Typical output characteristics



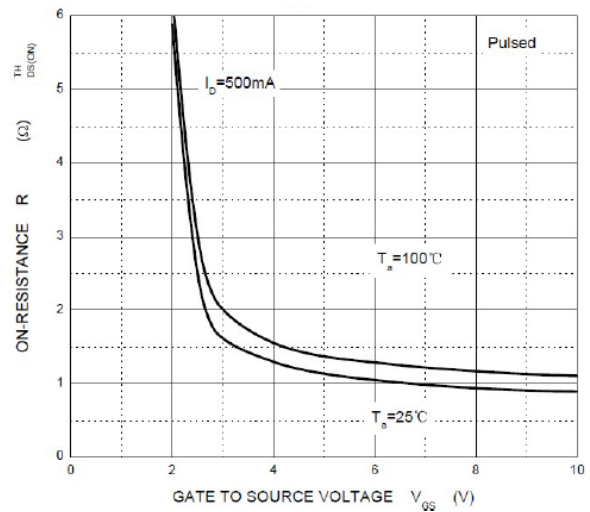
Transfer Characteristics



$R_{DS(on)}$ vs. I_D

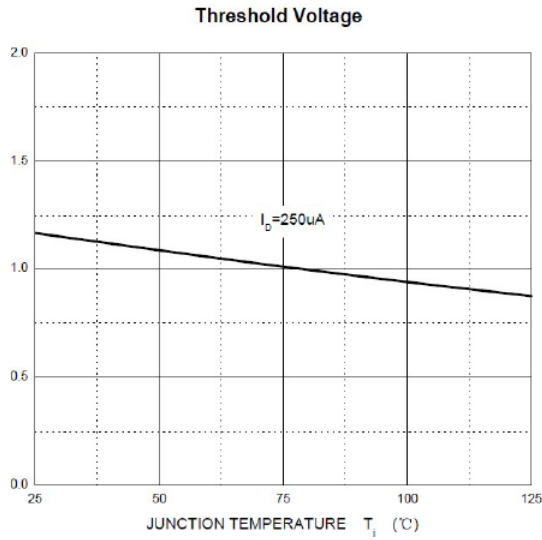


$R_{DS(on)}$ vs. V_{GS}

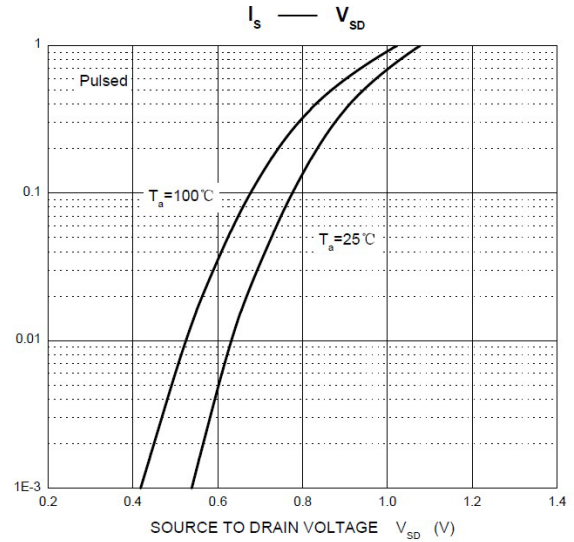


Typical characteristics

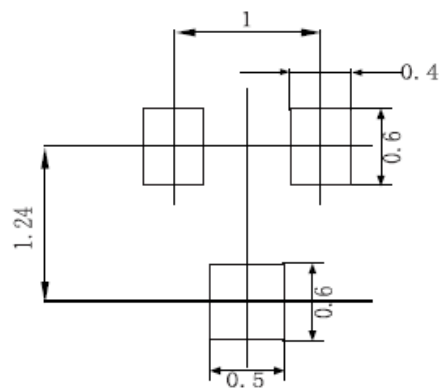
Normalized Threshold Voltage



Is vs. VSD



Pad dimensions



Ordering information			
Part Number	Package	Shipping Quantity	Dimensions
BSS138T	SOT-523	3000 pcs / reel	---

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